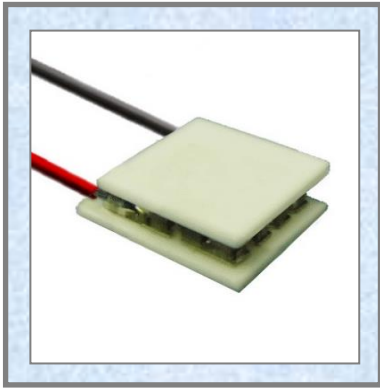


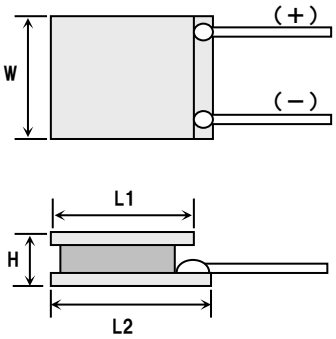
THERMO MODULE DATA

Model **KSM-04007C** [RoHS (EU) 2015/863 Compliant]



Th	$\Delta T_{max}(^{\circ}C)$	I _{max} (A)	V _{max} (v)	Q _{cmax} (w)
27°C	68	4.0	0.8	1.9
70°C	84	4.0	1.0	2.3

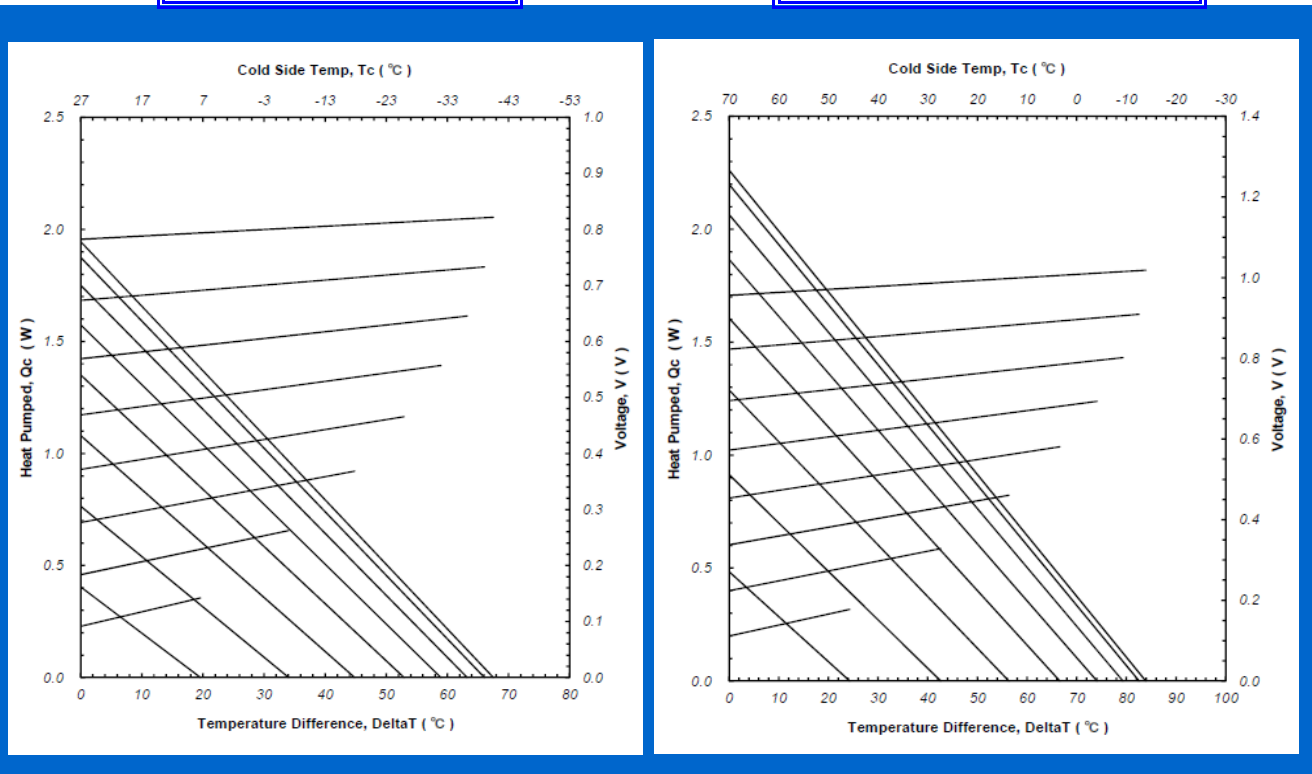
	W	L1	L2	H
Size(mm)	10.3	10.3	12.2	4.65
Tolerance(mm)	±0.5	±0.5	±0.5	±0.15
Metallization	Nil			
Ceramic material	Alumina			
Assembly solder	SnAgCu (melting point : 217°C)			



Performance Diagram

Th=27°C

Th=70°C



Ambient

Nitrogen

Current value

I = 0.5 - 4.0 A (Step = 0.5 A)

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